Express Mail Number EL25406420305

FORM PTC-1595

MND,

01-03-2000



U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

12/10/00	
o the Commissioner of Patents and Traden 101235	931 L documents or copy thereof.
. Name of conveying party(ies): ABU-HENA MOSTAFA KAMAL	2. Name and address of receiving party(ies):
	Name: NATIONAL SEMICONDUCTOR CORPORATION
dditional name(s) of conveying party(ies) attached?	Internal Address: M/S D3-579
Yes X No	Street Address: 2900 Semiconductor Drive
. Nature of Conveyance:	— City, State and Zip: <u>Santa Clara, CA 95051-8090</u>
X Assignment	Additional Name(s) & address(es) attached? Yes X No
Security Agreement ' Change of Name Other	
Execution Date: 12/09/99	_
. Application number(s) or patent number(s):	
If this document is being filed together with a new applic	ation, the execution date of the application is: 12/09/99
A. Patent Application No.(s) New	B. Patent No.(s)
Additional numbers attached?	Yes X No 09/1159135
. Name and address of party to whom correspondence concernin document should be mailed:	6. Total number of applications and patents involved: 1
Name: Mayumi Maeda	7. Total fee (37 CFR 3.41):\$_40.00
Internal Address: Limbach & Limbach L.L.P. Street Address: 2001 Ferry Building City, State, ZIP: San Francisco, California 94111 Telephone: (415) 433-4150	Enclosed Charge any deficiencies in the enclosed fee to Deposit Account No. 12-1420 Authorized to be charged to deposit account
// (415) 433-8716	8. Deposit account number: 12-1420
F Attorney Docket No. NSC1-445QQ [PO\$575]	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USI	E THIS SPACE
. Statement and signature.	
To the best of my knowledge and belief, the foregoing information is true a	and correct and any attached copy is a true copy of the original document.
Mayumi Maeda, Reg. No. 40,075	2/10/99 Signature Date
	f pages including cover sheet, attachments and document: 2
Do not date	ich this portion
Mail documents to be recorded with required cover sheet information to:	en one portion
	s, Box Assignments, Washington, D.C. 20231
Public burden reporting for this sample cover sheet is estimated to average a document and gathering the data needed, and completing and reviewing the	about 30 minutes per document to be recorded, including time for reviewing the sample cover sheet. Send comments regarding this burden estimate to the U.S. assigned by 10, 20213, and to the Office of Management and Budget, Propagately

Reduction Project. (0651-0011), Washington, D.C. 20503

Attorney Docket No. NSC1-G4500 [PO4575]

ASSIGNMENT

WHEREAS, I, <u>ABU-HENA MOSTAFA KAMAL</u>, hereinafter referred to as "ASSIGNOR", have invented certain new and useful improvements as described and set forth in the below-identified application for United States Letters Patent:

Title of Invention: METHOD FOR THE FORMATION OF A POLYSILICON LAYER WITH A CONTROLLED, SMALL SILICON GRAIN SIZE DURING SEMICONDUCTOR DEVICE FABRICATION Application Execution Date: _ Filing Date: Application No.: ; WHEREAS, NATIONAL SEMICONDUCTOR CORPORATION, a corporation of the State of Delaware, 2900 Semiconductor Drive, M/S D3-579, Santa Clara, California 95051-8090, hereinafter referred to as "ASSIGNEE", is desirous of acquiring the entire right, title and interest in the said invention and application and in any Letters Patent which may be granted on the same; NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for One Dollar (\$1.00) and other good and valuable considerations, receipt of which is hereby acknowledged by Assignor, Assignor has sold, assigned and transferred, and by these presents does sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all right, title and interest in and to the said invention, said application for United States Letters Patent, and any Letters Patent which may hereafter be granted on the same in the United States and all countries throughout the world including any divisions, renewals, continuations in whole or in part, substitutions, conversions, reissues, prolongations or extensions thereof, said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this assignment and transfer not been made, to the full end and term of any such Letters Patent. Assignor further agrees that he will, without charge to said Assignee, but at Assignee's expense. cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement in any and all countries, and to vest title thereto in said Assignee, or Assignee's successors and assigns. I hereby authorize and request my attorney, Mayumi Maeda, of Limbach & Limbach L.L.P., 2001 Ferry Building, San Francisco, California 94111-4262, to insert here in parentheses (application _, filed _ _____) the filing date and application number of said application when known. IN TESTIMONY WHEREOF, Assignor has hereunto signed his/her name to this assignment on the date indicated below. personally appeared how how must be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument. WITNESS my hand and official seal.

NSC\ASMT1.MRG

SEAL

PATENT 07/20/98
REEL: 010471 FRAME: 0159